

Diode

Silicon Carbide Schottky Diode

IDH20G120C5

5th Generation CoolSiC™ 1200 V SiC Schottky Diode

IDH20G120C5

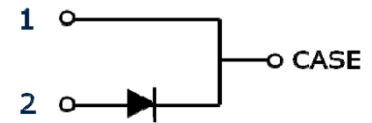
Rev. 2.1 2017-07-21

Industrial Power Control

CoolSiC™ SiC Schottky Diode

Features:

- Revolutionary semiconductor material - Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant



Benefits

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: www.infineon.com/sic



Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

- Pin 1 and backside – cathode
- Pin 2 – anode



Key Performance and Package Parameters

Type	V _{DC}	I _F	Q _C	T _{j,max}	Marking	Package
IDH20G120C5	1200V	20A	82nC	175°C	D2012C5	PG-TO220-2-1

1) J-STD20 and JEDEC22

Table of Contents

Description	2
Table of Contents	3
Maximum Ratings	4
Thermal Resistances	4
Electrical Characteristics	5
Electrical Characteristics Diagram	6
Package Drawings	9
Revision History	10
Disclaimer	11

Maximum ratings

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	1200	V
Continues forward current for $R_{th(j-c,max)}$ $T_C = 150^\circ\text{C}$, $D=1$ $T_C = 135^\circ\text{C}$, $D=1$ $T_C = 25^\circ\text{C}$, $D=1$	I_F	20 27 56	A
Surge non-repetitive forward current, sine halfwave $T_C=25^\circ\text{C}$, $t_p=10\text{ms}$ $T_C=150^\circ\text{C}$, $t_p=10\text{ms}$	$I_{F,SM}$	198 168	A
Non-repetitive peak forward current $T_C = 25^\circ\text{C}$, $t_p=10 \mu\text{s}$	$I_{F,max}$	1200	A
i^2t value $T_C = 25^\circ\text{C}$, $t_p=10 \text{ms}$ $T_C = 150^\circ\text{C}$, $t_p=10 \text{ms}$	$\int i^2 dt$	195 140	A ² s
Diode dv/dt ruggedness $V_R=0\dots960\text{V}$	dv/dt	80	V/ns
Power dissipation $T_C = 25^\circ\text{C}$	P_{tot}	330	W
Operating and storage temperature	$T_j; T_{stg}$	-55...175	$^\circ\text{C}$
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T_{sold}	260	$^\circ\text{C}$
Mounting torque M3 and M4 screws	M	0.7	Nm

Thermal Resistances

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Characteristic						
Diode thermal resistance, junction – case	$R_{th(j-c)}$		-	0.35	0.46	K/W
Thermal resistance, junction – ambient	$R_{th(j-a)}$	leaded	-	-	62	K/W

Electrical Characteristics
Static Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
DC blocking voltage	V _{DC}	T _j = 25°C	1200	-	-	V
Diode forward voltage	V _F	I _F = 20A, T _j =25°C	-	1.5	1.8	V
		I _F = 20A, T _j =150°C	-	2.0	2.6	
Reverse current	I _R	V _R =1200V, T _j =25°C		8.5	123	μA
		V _R =1200V, T _j =150°C		44	630	

Dynamic Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristics						
Total capacitive charge	Q _C	V _R =800V, T _j =150°C $Q_C = \int_0^{V_R} C(V)dV$	-	82	-	nC
Total Capacitance	C	V _R =1 V, f=1 MHz	-	1050	-	pF
		V _R =400 V, f=1 MHz	-	74	-	
		V _R =800 V, f=1 MHz	-	59	-	

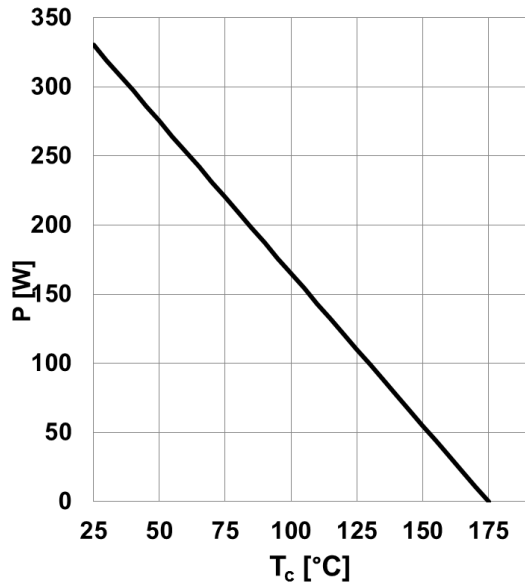


Figure 1. Power dissipation as a function of case temperature, $P_{tot}=f(T_c, R_{th(j-c),max})$

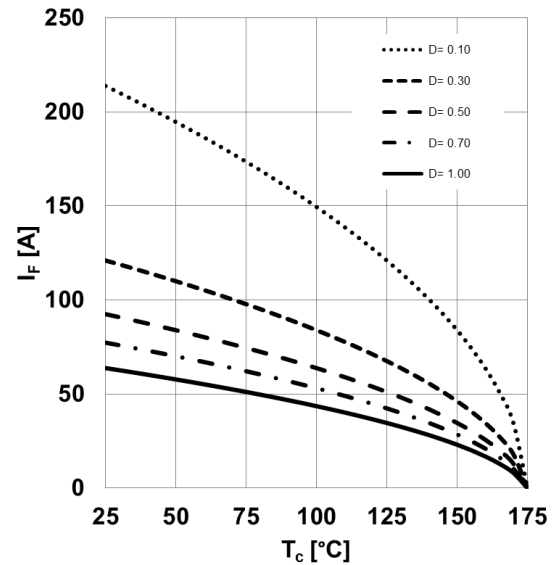


Figure 2. Diode forward current as function of temperature, $T_j \leq 175^\circ\text{C}$, $R_{th(j-c),max}$, parameter D =duty cycle, V_{th} , R_{diff} @ $T_j=175^\circ\text{C}$

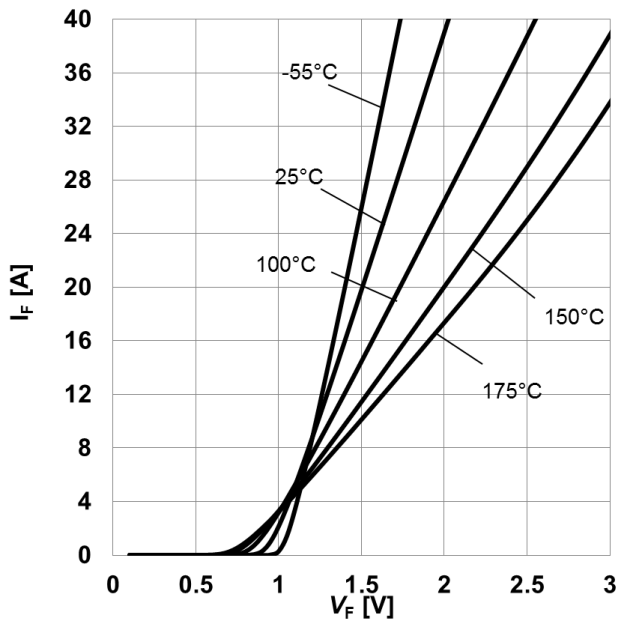


Figure 3. Typical forward characteristics, $I_F=f(V_F)$, $t_p=10 \mu\text{s}$, parameter: T_j

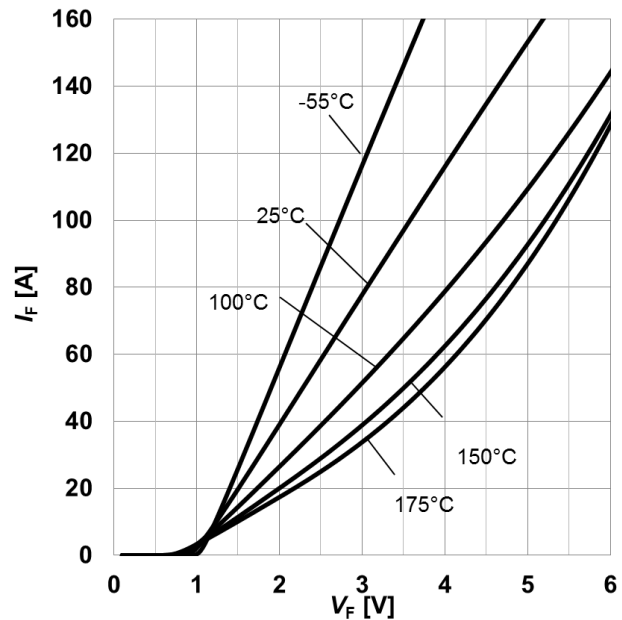


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10 \mu\text{s}$, parameter: T_j

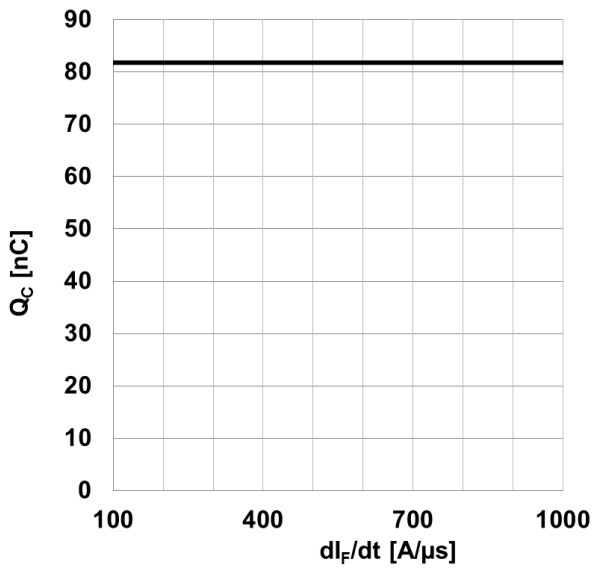


Figure 5. **Typical capacitive charge as function of current slope**¹, $Q_C=f(di_F/dt)$, $T_j=150^\circ\text{C}$
 1) Only capacitive charge, guaranteed by design.

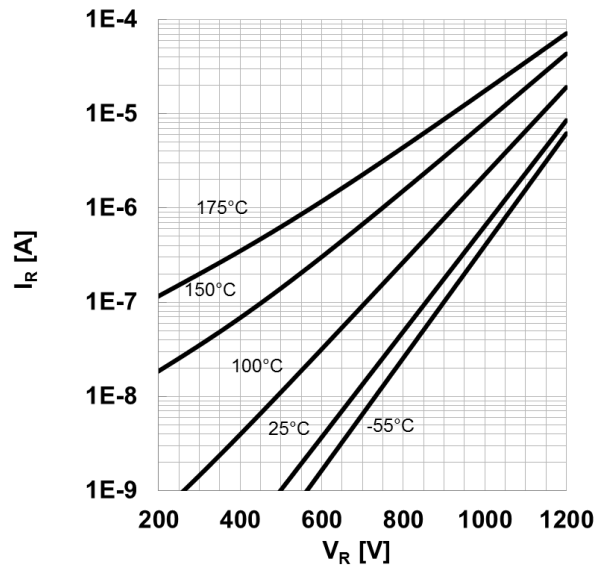


Figure 6. **Typical reverse current as function of reverse voltage**, $I_R=f(V_R)$, parameter: T_j

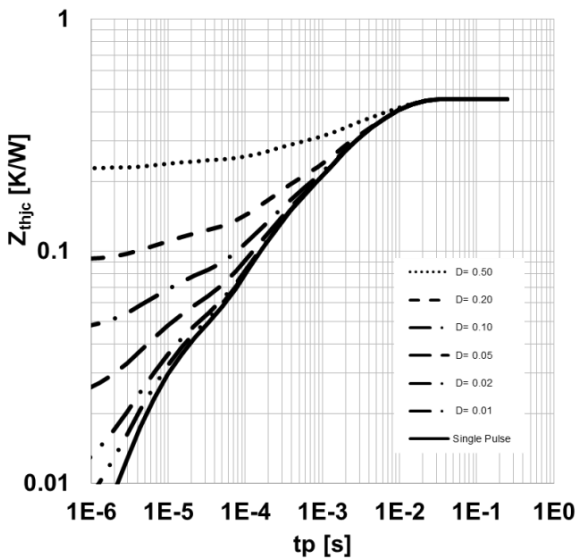


Figure 7. **Max. transient thermal impedance**, $Z_{th,jc}=f(t_p)$, parameter: $D=t_p/T$

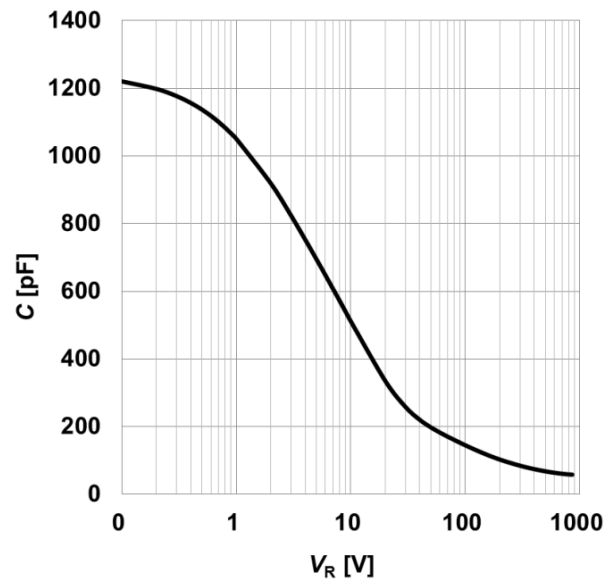


Figure 8. **Typical capacitance as function of reverse voltage**, $C=f(V_R)$; $T_j=25^\circ\text{C}$; $f=1\text{ MHz}$

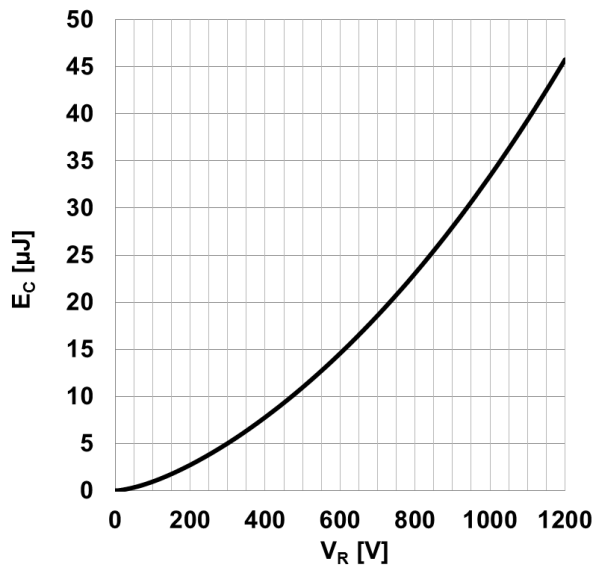
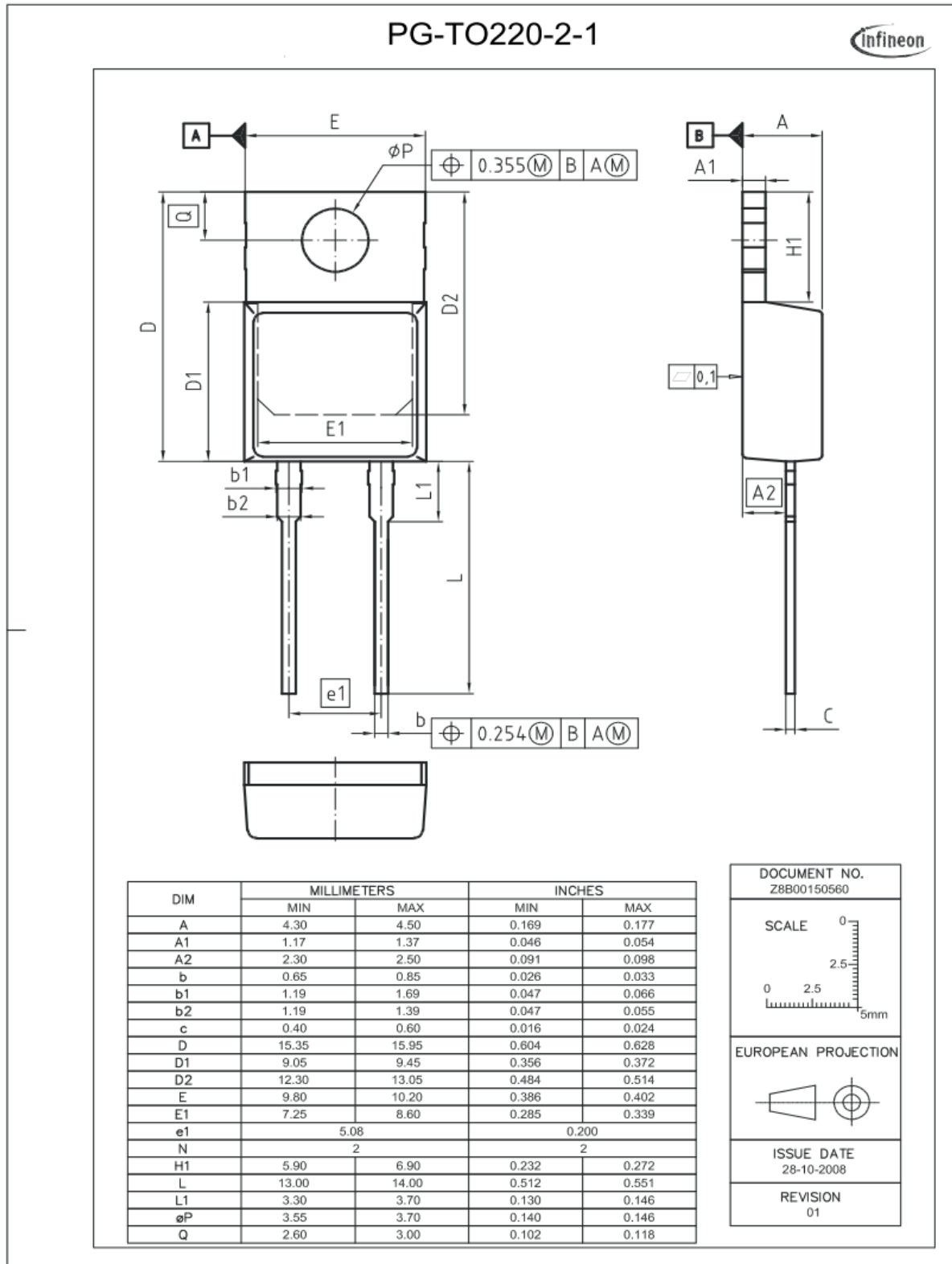


Figure 9. Typical capacitively stored energy as function of reverse voltage,

$$E_C = \int_0^{V_R} C(V)VdV$$



Revision HistoryIDH20G120C5

Revision: 2017-07-21, Rev. 2.1Previous Revision:

Revision	Date	Subjects (major changes since last version)
2.0	2015-09-03	Final data sheet
2.1	-	Editorial Changes

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